

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: J. TAKETATSU, ET AL.
Serial No.: 10/585,461
Filed: MAY 27, 2009
Title: CIRCUIT CONNECTION MATERIAL, FILM-SHAPED CIRCUIT
CONNECTION MATERIAL USING THE SAME, CIRCUIT
MEMBER CONNECTION STRUCTURE AND
MANUFACTURING METHOD THEREOF
Group AU: 2835
Examiner: Ishwarbhai B. Patel
Confirm. No.: 5965

**INFORMATION DISCLOSURE STATEMENT
UNDER 37 CFR 1.97 AND 1.98****Mail Stop: AMEND – NO FEE**

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

May 26, 2011

Sir:

Pursuant to Applicants' duty of disclosure, enclosed please find a copy of an Official Action issued on March 17, 2011, in a counterpart Singapore patent application. Also enclosed are copies of documents cited therein, other than U.S. patent documents and documents previously cited in the above-identified application. That is, JP 7-133466, JP 2002-167555 and JP 2002-164389, previously cited in the above-identified application in the Information Disclosure Statement filed July 7, 2006, are not enclosed herewith. Still further enclosed is a Form PTO/SB/08A, listing the enclosed documents, as well as U.S. Patent Application Publication No. 2003/0027942, also cited in the enclosed Official Action. USP 5,162,087, cited in the enclosed Official Action, has previously been cited in the above-identified application, in the Information Disclosure Statement filed March 11, 2009, in the above-identified application.

May 26, 2011

This Information Disclosure Statement is being submitted prior to a first Office Action on the merits in the above identified-application. Accordingly, requirements of 37 CFR 1.97 (b) are satisfied.

To the extent that the enclosed documents are not in English, it is respectfully submitted that requirements of 37 CFR 1.98(a)(3) are satisfied, by the enclosed English abstracts of the enclosed documents, and/or by the enclosed Written Opinion and enclosed Search Report of the Official Action issued on March 17, 2011, enclosed herewith.

In view of the foregoing, it is respectfully submitted that all applicable requirements of 37 CFR 1.97 and 1.98 have been satisfied, in connection with each of the documents listed on the enclosed Form. Consideration of the listed documents, upon examination of the above identified application, is respectfully requested.

Please charge any shortage of fees due in connection with the filing of this paper to the Deposit Account of Antonelli, Terry, Stout & Kraus, LLP, Deposit Account No. 01-2135 (case No. 1303.46354X00), or credit any excess fees paid to such Deposit Account.

Respectfully submitted,

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